

# BAP64Q

## Quad PIN diode attenuator

Rev. 1 — 7 October 2010

Product data sheet

## 1. Product profile

### 1.1 General description

Quad PIN diode in a SOT753 package.

### 1.2 Features and benefits

- 4 PIN diodes in a SOT753 package
- 300 kHz to 4 GHz
- High linearity
- Low insertion loss
- reduction in part count
- Low diode capacitance
- Low diode forward resistance

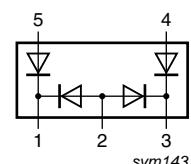
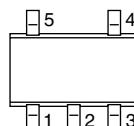
### 1.3 Applications

- RF attenuators
- Broadband system applications
- General purpose Voltage Controlled Attenuators for high linearity applications

## 2. Pinning information

Table 1. Discrete pinning

Pin	Description	Simplified outline	Graphic symbol
1	RF in		
2	series bias		
3	RF out		
4	shunt 1 bias		
5	shunt 2 bias		



sym143

## 3. Ordering information

Table 2. Ordering information

Type number	Package		Version
	Name	Description	
BAP64Q	SC-74A	plastic surface-mounted package; 5 leads	SOT753



## 4. Marking

**Table 3. Marking**

Type number	Marking code
BAP64Q	A1

## 5. Limiting values

**Table 4. Limiting values**

*In accordance with the Absolute Maximum Rating System (IEC 60134).*

Symbol	Parameter	Conditions	Min	Max	Unit
$V_R$	reverse voltage	[1]	-	100	V
$I_F$	forward current	[1]	-	100	mA
$P_{tot}$	total power dissipation	$T_{sp} = 90^\circ\text{C}$	[1]	-	125 mW
$T_{stg}$	storage temperature		-65	+150	°C
$T_j$	junction temperature		-65	+150	°C

[1] single diode.

## 6. Thermal characteristics

**Table 5. Thermal characteristics**

Symbol	Parameter	Conditions	Typ	Unit
$R_{th(j-sp)}$	thermal resistance from junction to solder point		350	K/W

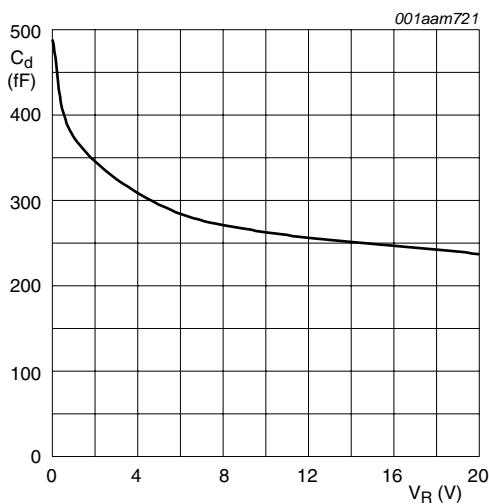
## 7. Characteristics

**Table 6. Characteristics**

$T_j = 25^\circ\text{C}$  unless otherwise specified.

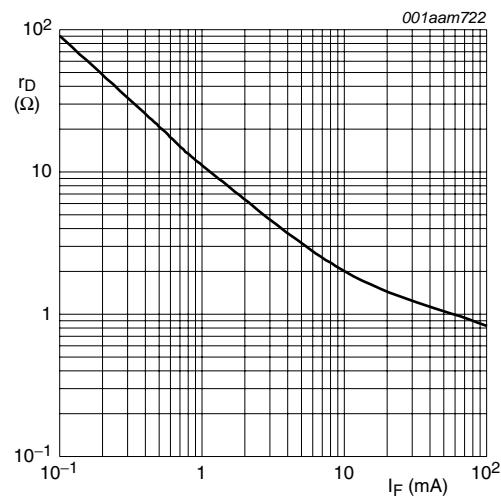
Symbol	Parameter	Conditions	Min	Typ	Max	Unit	
<b>Per diode</b>							
$V_F$	forward voltage	$I_F = 50 \text{ mA}$	-	0.95	1.1	V	
$I_R$	reverse current	$V_R = 20 \text{ V}$	-	-	1	$\mu\text{A}$	
		$V_R = 100 \text{ V}$	-	-	10	$\mu\text{A}$	
$C_d$	diode capacitance	$f = 1 \text{ MHz}$ ; see <a href="#">Figure 1</a>					
		$V_R = 0 \text{ V}$	-	0.52	-	pF	
		$V_R = 1 \text{ V}$	-	0.37	-	pF	
		$V_R = 20 \text{ V}$	-	0.23	0.35	pF	
$r_D$	diode forward resistance	$f = 100 \text{ MHz}$ ; see <a href="#">Figure 2</a>					
		$I_F = 0.5 \text{ mA}$	[1]	-	20	40	$\Omega$
		$I_F = 1 \text{ mA}$	[1]	-	10	20	$\Omega$
		$I_F = 10 \text{ mA}$	[1]	-	2	3.8	$\Omega$
		$I_F = 100 \text{ mA}$	[1]	-	0.7	1.35	$\Omega$
$\tau_L$	charge carrier life time	when switched from $I_F = 10 \text{ mA}$ to $I_R = 6 \text{ mA}$ ; $R_L = 100 \Omega$ ; measured at $I_R = 3 \text{ mA}$	-	1.55	-	$\mu\text{s}$	

[1] Guaranteed on AQL basis: inspection level S4, AQL 1.0.



$f = 1 \text{ MHz}; T_j = 25^\circ\text{C}$ .

**Fig 1. Diode capacitance as a function of reverse voltage; typical values.**



$f = 100 \text{ MHz}; T_j = 25^\circ\text{C}$ .

**Fig 2. Diode forward resistance as a function of forward current; typical values.**

## 8. Application information

### 8.1 Application circuit

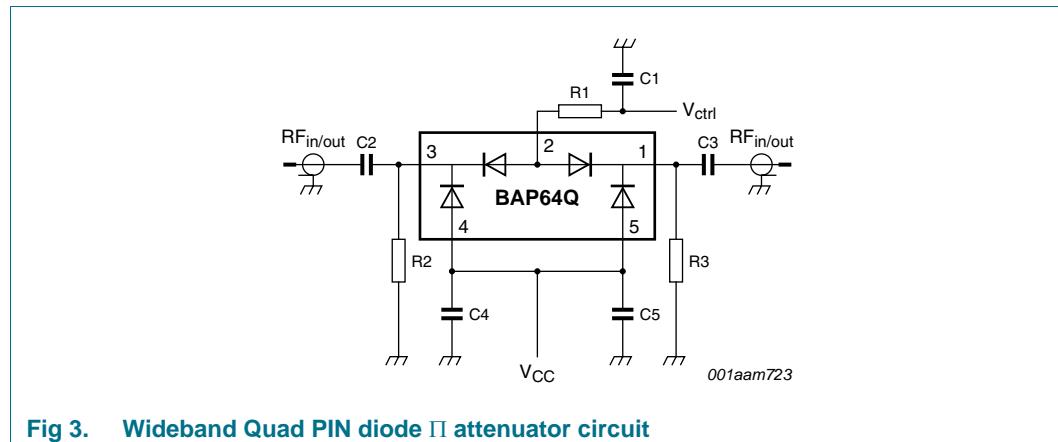


Fig 3. Wideband Quad PIN diode  $\Pi$  attenuator circuit

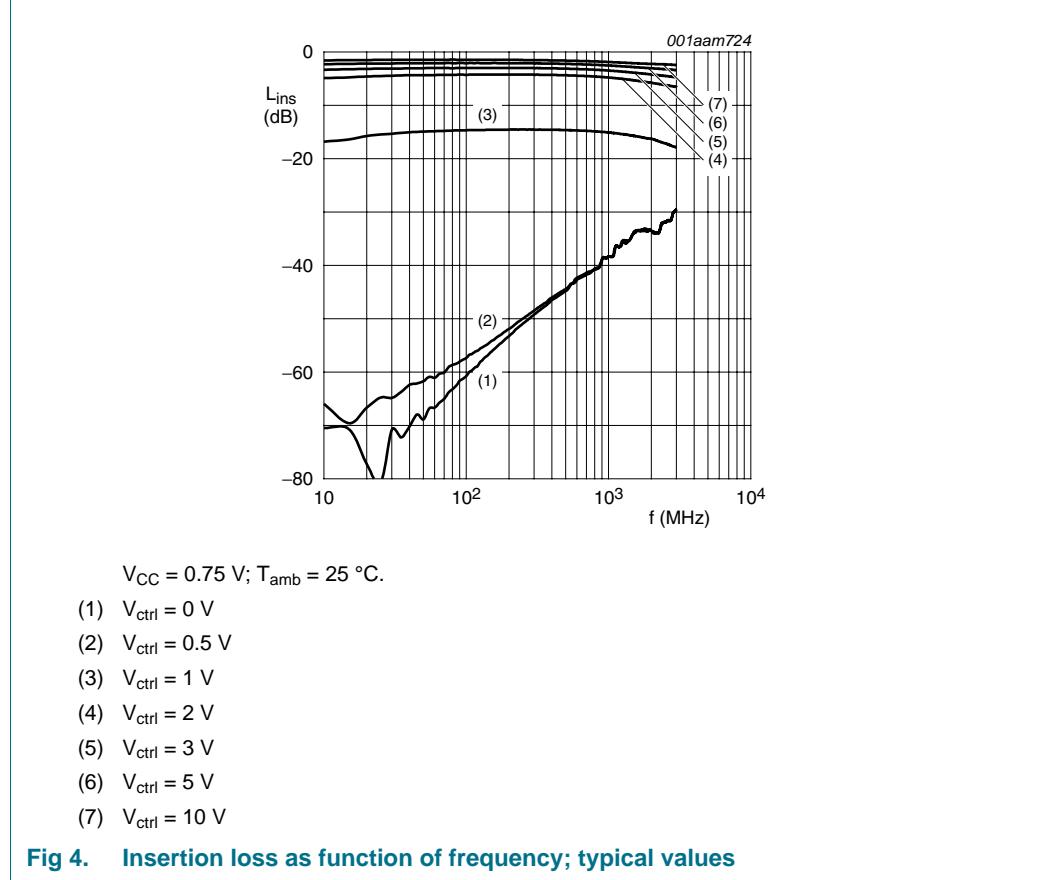
Table 7. List of components used for the typical application

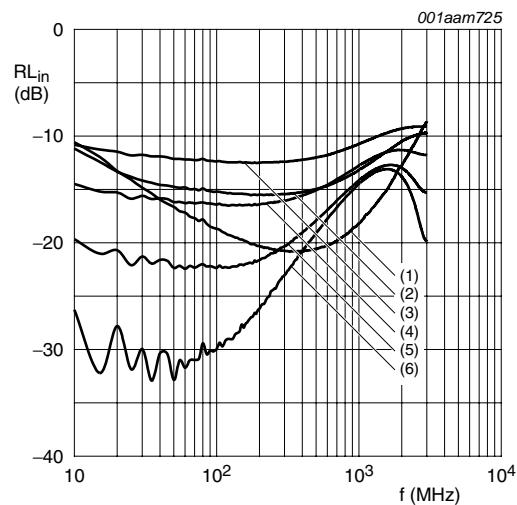
Component	Description	Value
C1, C2, C3, C4, C5	chip capacitor	10 nF
R1, R2, R3	chip resistor	1000 $\Omega$

## 8.2 Quad PIN pi attenuator characteristics

**Table 8. Typical performance for BAP64Q quad PIN diode  $\Pi$  attenuator**  
 $V_{CC} = 0.75$  V;  $T_{amb} = 25$  °C unless otherwise specified.

Symbol	Parameter	Test Conditions	Typ	Units
$L_{ins}$	insertion loss	$V_{ctrl} = 10$ V; $f = 1$ GHz	1.8	dB
$RL_{in}$	input return loss	$V_{ctrl} = 0$ V; $f = 1$ GHz	18	dB
$\alpha$	attenuation	$V_{ctrl} = 0$ V; $f = 1$ GHz	38	dB
$IP3_i$	input third-order intercept point	$f = 0.1$ GHz		
		$V_{ctrl} = 2$ V	32	dBm
		$V_{ctrl} = 10$ V	42	dBm
		$f = 0.9$ GHz		
		$V_{ctrl} = 2$ V	40	dBm
		$V_{ctrl} = 10$ V	41	dBm
		$f = 1.8$ GHz		
		$V_{ctrl} = 2$ V	40	dBm
		$V_{ctrl} = 10$ V	37	dBm
		$f = 2.1$ GHz		
		$V_{ctrl} = 2$ V	38	dBm
		$V_{ctrl} = 10$ V	39	dBm

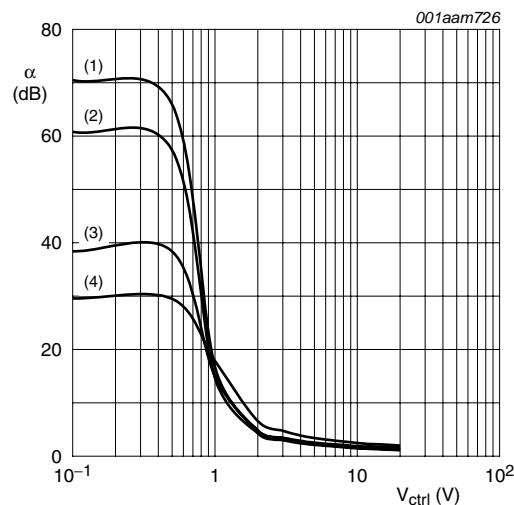




$V_{CC} = 0.75$  V;  $T_{amb} = 25$  °C.

- (1)  $V_{ctrl} = 0$  V
- (2)  $V_{ctrl} = 1$  V
- (3)  $V_{ctrl} = 2$  V
- (4)  $V_{ctrl} = 3$  V
- (5)  $V_{ctrl} = 5$  V
- (6)  $V_{ctrl} = 10$  V

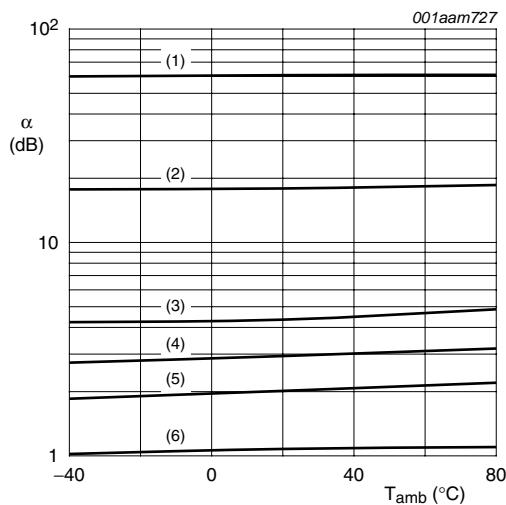
**Fig 5. Return loss as function of frequency; typical values**



$V_{CC} = 0.75$  V;  $T_{amb} = 25$  °C.

- (1)  $f = 10$  MHz
- (2)  $f = 100$  MHz
- (3)  $f = 1000$  MHz
- (4)  $f = 3000$  MHz

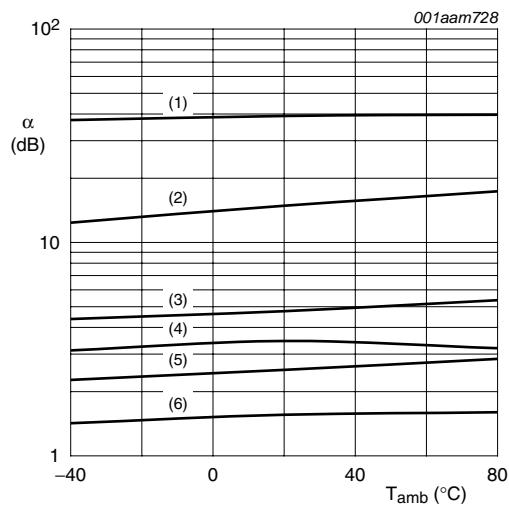
**Fig 6. Attenuation as function of control voltage; typical values**



$V_{CC} = 0.75$  V;  $f = 100$  MHz.

- (1)  $V_{ctrl} = 0$  V
- (2)  $V_{ctrl} = 1$  V
- (3)  $V_{ctrl} = 2$  V
- (4)  $V_{ctrl} = 3$  V
- (5)  $V_{ctrl} = 5$  V
- (6)  $V_{ctrl} = 10$  V

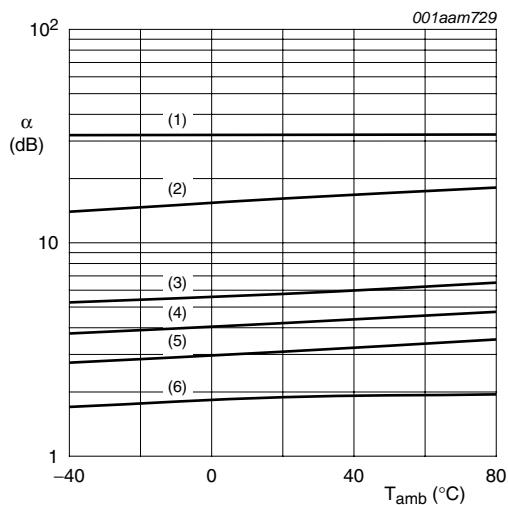
**Fig 7. Attenuation as function of temperature; typical values**



$V_{CC} = 0.75$  V;  $f = 1000$  MHz.

- (1)  $V_{ctrl} = 0$  V
- (2)  $V_{ctrl} = 1$  V
- (3)  $V_{ctrl} = 2$  V
- (4)  $V_{ctrl} = 3$  V
- (5)  $V_{ctrl} = 5$  V
- (6)  $V_{ctrl} = 10$  V

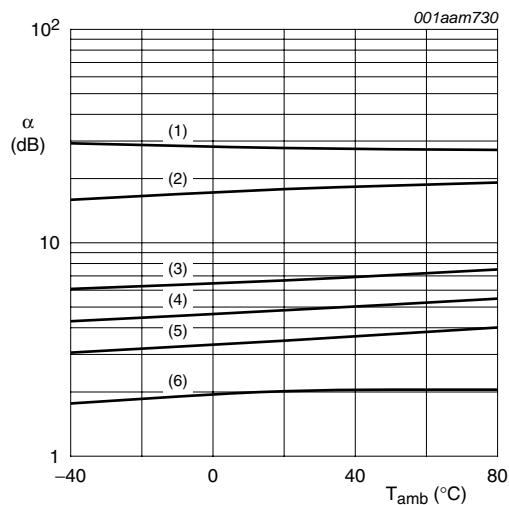
**Fig 8. Attenuation as function of temperature; typical values**



$V_{CC} = 0.75$  V;  $f = 2000$  MHz.

- (1)  $V_{ctrl} = 0$  V
- (2)  $V_{ctrl} = 1$  V
- (3)  $V_{ctrl} = 2$  V
- (4)  $V_{ctrl} = 3$  V
- (5)  $V_{ctrl} = 5$  V
- (6)  $V_{ctrl} = 10$  V

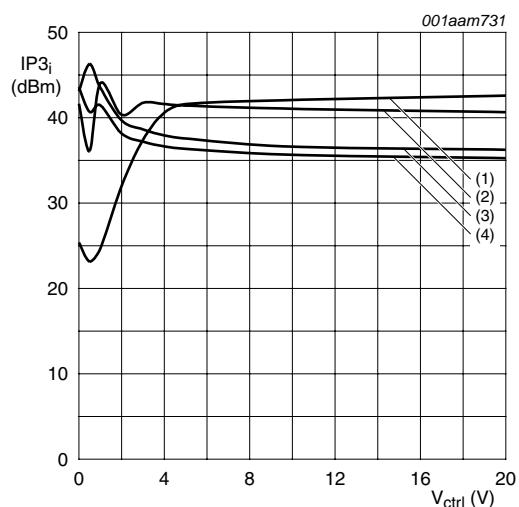
**Fig 9. Attenuation as function of temperature; typical values**



$V_{CC} = 0.75$  V;  $f = 3000$  MHz.

- (1)  $V_{ctrl} = 0$  V
- (2)  $V_{ctrl} = 1$  V
- (3)  $V_{ctrl} = 2$  V
- (4)  $V_{ctrl} = 3$  V
- (5)  $V_{ctrl} = 5$  V
- (6)  $V_{ctrl} = 10$  V

**Fig 10. Attenuation as function of temperature; typical values**



$V_{CC} = 0.75$  V;  $T_{amb} = 25$   $^{\circ}$ C.

- (1)  $f = 100$  MHz
- (2)  $f = 900$  MHz
- (3)  $f = 1800$  MHz
- (4)  $f = 2100$  MHz

**Fig 11. Input third-order intercept point as control voltage; typical values**

## 9. Package outline

Plastic surface-mounted package; 5 leads

SOT753

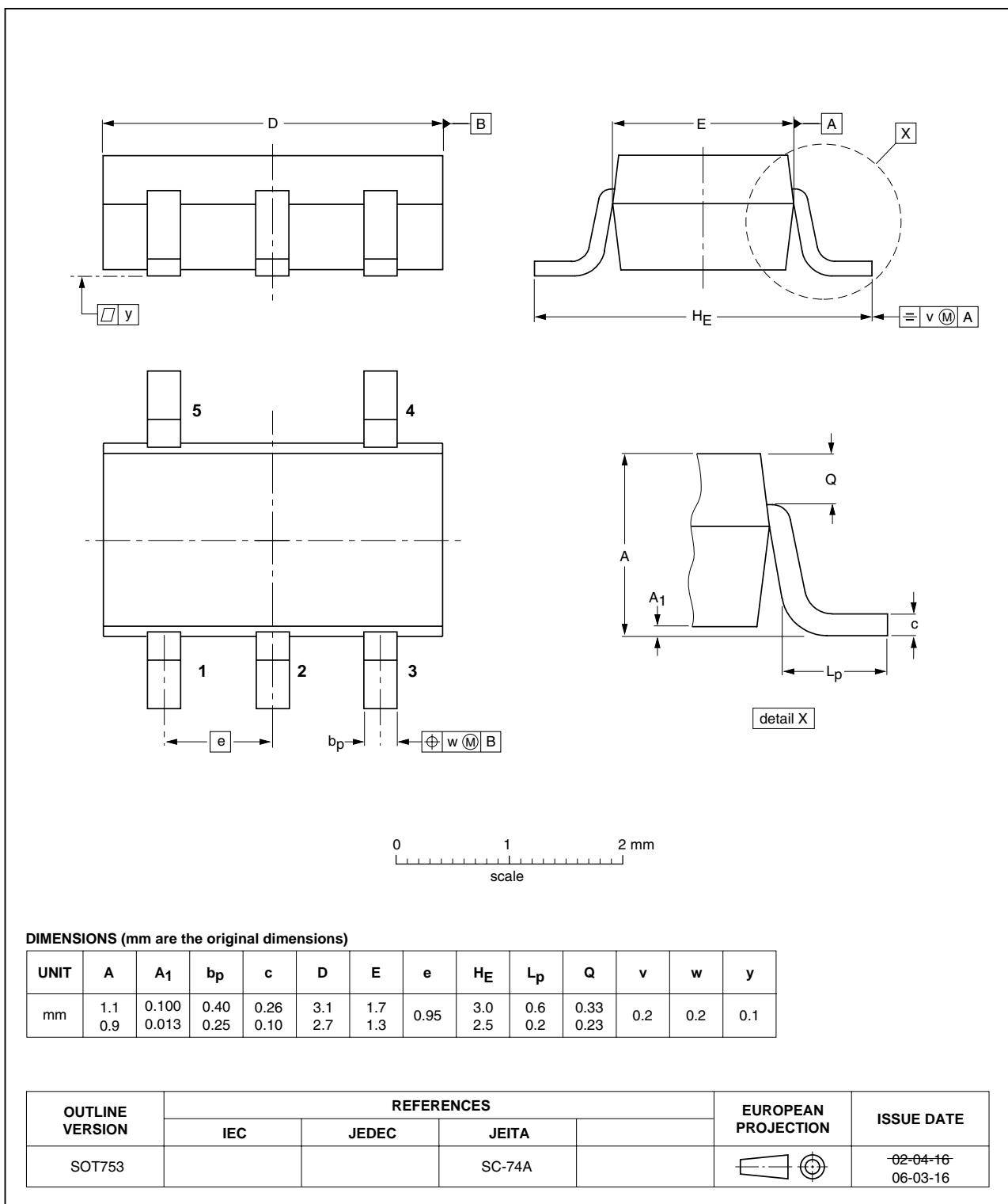


Fig 12. Package outline SOT753

## 10. Abbreviations

**Table 9. Abbreviations**

Acronym	Description
AQL	Acceptable Quality Level
PIN	P-type, Intrinsic, N-type
RF	Radio Frequency
S4	Special inspection level 4

## 11. Revision history

**Table 10. Revision history**

Document ID	Release date	Data sheet status	Change notice	Supersedes
BAP64Q v.1	20101007	Product data sheet	-	-

## 12. Legal information

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Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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